



#### 8A LOW VF SCHOTTKY BARRIER RECTIFIER PowerDI®5

#### **Features**

- Guard Ring Die Construction for Transient Protection
- Low Forward Voltage Drop
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- High Forward Surge Current Capability
- Lead Free Finish, RoHS Compliant (Note 1)
- "Green" Molding Compound (No Br, Sb)
- Qualified to AEC-Q101 Standards for High Reliability

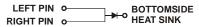
#### **Mechanical Data**

- Case: PowerDI<sup>®</sup>5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.094 grams (approximate)



Top View





Note: Pins Left & Right must be electrically connected at the printed circuit board.

#### Ordering Information (Note 2)

Part Number	Case	Packaging
PDS835L-13	PowerDI <sup>®</sup> 5	5000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
- 2. For packaging details, go to our website at http://www.diodes.com.

## **Marking Information**



S835L = Product type marking code

O!! = Manufacturers' code marking

YYWW = Date code marking

YY = Last two digits of year (ex: 04 for 2004)

WW = Week code (01 - 53)

K = Factory Designator

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### Maximum Ratings @TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	35	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	25	V
Average Rectified Output Current (See also figure 5)	lo	8	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	120	A

### **Thermal Characteristics**

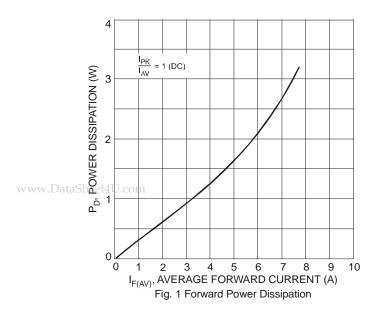
Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance Junction to Soldering Point	$R_{ heta}$ JS	_	3.0	°C/W
Thermal Resistance Junction to Ambient Air (Note 3) T <sub>A</sub> = 25°C	$R_{ heta JA}$	100	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 4) T <sub>A</sub> = 25°C	$R_{ hetaJA}$	65	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 5) T <sub>A</sub> = 25°C	$R_{ heta JA}$	45	_	°C/W
Operating Temperature Range	TJ	-65 to +125		°C
Storage Temperature Range	T <sub>STG</sub>	-65 to +150		°C

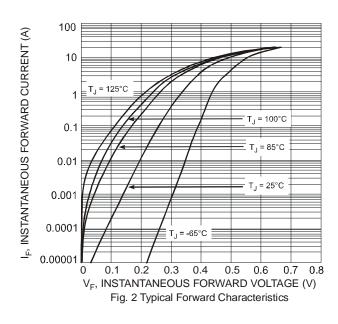
## Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	35	_	_	V	$I_R = 1mA$
Forward Voltage	Voltage V <sub>F</sub>		0.46	0.51	V	$I_F = 8A, T_S = 25^{\circ}C$
1 orward voilage	۷F	—	_	0.41		$I_F = 8A, T_S = 125^{\circ}C$
Reverse Leakage Current (Note 6)	I <sub>R</sub>	_	0.05	1.4		$T_S = 25^{\circ}C, V_R = 35V$
		_	7	35		$T_S = 100^{\circ}C, V_R = 35V$

Notes:

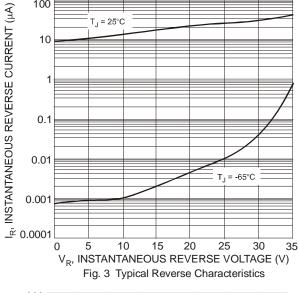
- 3. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com
- 4. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
- 5. Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
- 6. Short duration pulse test used to minimize self-heating effect.

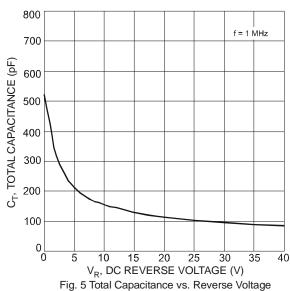


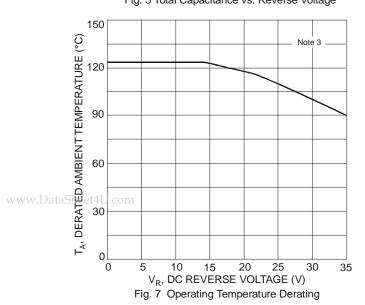


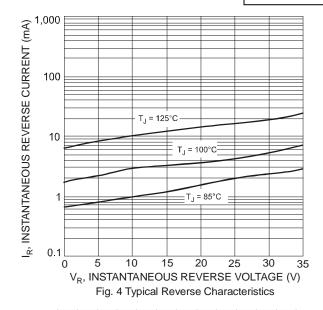
PowerDI is a registered trademark of Diodes Incorporated.

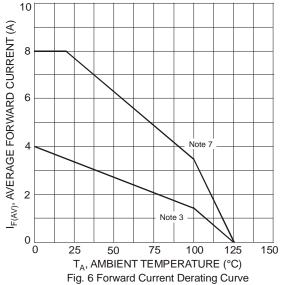








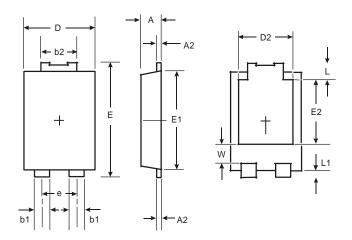




otes: 7. Polymide PCB, 2 oz. Copper. Cathode pad dimensions 18.8mm x 14.4mm. Anode pad dimensions 5.6mm x 3.0mm.

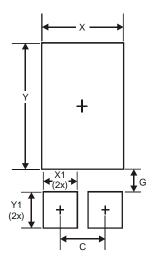


# **Package Outline Dimensions**



PowerDI <sup>®</sup> 5				
Dim	Min	Max		
Α	1.05	1.15		
A2	0.33	0.43		
b1	0.80	0.99		
b2	1.70	1.88		
D	3.90	4.05		
D2	3.054 Typ			
E	6.40	6.60		
е	1.84	Тур		
E1	5.30	5.45		
E2	3.549	Тур		
L	0.75	0.95		
L1	0.50	0.65		
W	1.10	1.41		
All Di	All Dimensions in mm			

# Suggested Pad Layout



Dimensions	Value (in mm)
C	1.840
G	0.852
Х	3.360
X1	1.390
Y	4.860
Y1	1.400

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